## SN74ALS841, SN74AS841A, SN74ALS842 10-BIT BUS-INTERFACE D-TYPE LATCHES WITH 3-STATE OUTPUTS

SDAS059C - DECEMBER 1983 - REVISED JANUARY 1995

- 3-State Buffer-Type Outputs Drive Bus Lines Directly
- Bus-Structured Pinout
- Provide Extra Bus-Driving Latches Necessary for Wider Address/Data Paths or Buses With Parity
- Buffered Control Inputs to Reduce dc Loading Effects
- Power-Up High-Impedance State
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (NT) 300-mil DIPs

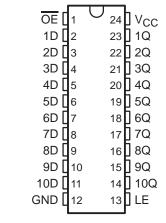
#### description

These 10-bit latches feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

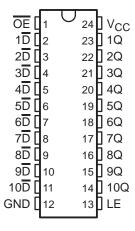
The ten latches are transparent D-type latches. The SN74ALS841 and SN74AS841A have noninverting data (D) inputs. The SN74ALS842 has inverting  $\overline{D}$  inputs.

A buffered output-enable  $(\overline{OE})$  input places the ten outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

# SN74ALS841, SN74AS841A . . . DW OR NT PACKAGE (TOP VIEW)



# SN74ALS842 . . . DW OR NT PACKAGE (TOP VIEW)



OE does not affect the internal operation of the latches. Previously stored data can be retained or new data can be entered while the outputs are off.

The SN74ALS841, SN74AS841A, and SN74ALS842 are characterized for operation from 0°C to 70°C.

#### **Function Tables**

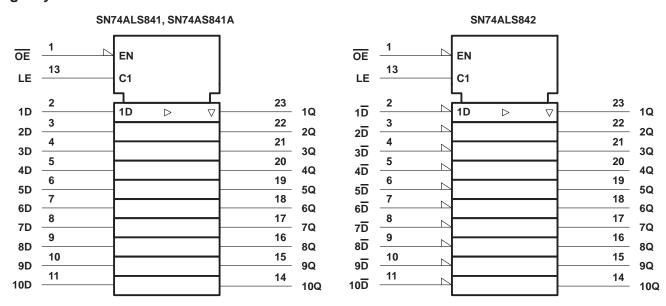
#### SN74ALS841, SN74AS841A

	INPUTS		OUTPUT
OE	LE	D	Q
L	Н	Н	Н
L	Н	L	L
L	L	Χ	Q <sub>0</sub>
Н	X	Χ	Z

#### SN74ALS842

	INPUTS		OUTPUT
OE	LE	D	Q
L	Н	Н	L
L	Н	L	н
L	L	Χ	Q <sub>0</sub>
Н	X	X	Z

## logic symbols†



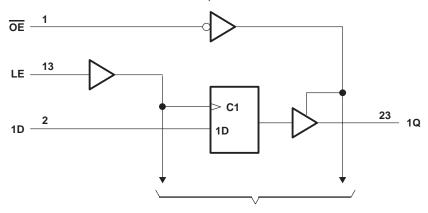
<sup>†</sup> These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



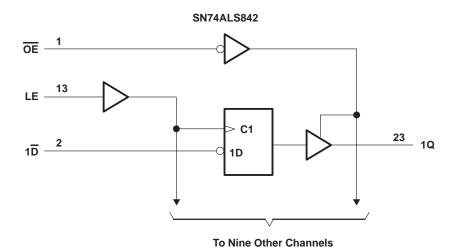
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## logic diagrams (positive logic)

#### SN74ALS841, SN74AS841A



**To Nine Other Channels** 



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub>	7 \/
Input voltage, V <sub>I</sub>	7 V
Voltage applied to a disabled 3-state output	
Operating free-air temperature range, T <sub>A</sub> : SN74ALS841, SN74ALS842	0°C to 70°C
Storage temperature range	-65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## SN74ALS841, SN74AS841A, SN74ALS842 10-BIT BUS-INTERFACE D-TYPE LATCHES WITH 3-STATE OUTPUTS

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## recommended operating conditions

		SN74ALS841 SN74ALS842			UNIT
		MIN	NOM	MAX	
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			0.8	V
IOH	High-level output current			-2.6	mA
loL	Low-level output current			24	mA
t <sub>W</sub>	Pulse duration, LE high	20			ns
t <sub>su</sub>	Setup time, data before LE↓	10			ns
t <sub>h</sub>	Hold time, data after LE↓	5			ns
TA	Operating free-air temperature	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST COND		SN74ALS841 SN74ALS842				
				MIN	TYP <sup>†</sup>	MAX	UNIT	
VIK		V <sub>CC</sub> = 4.5 V,	I <sub>I</sub> = -18 mA			-1.2	V	
V		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V <sub>CC</sub> -2			V	
VOH		$V_{CC} = 4.5 V,$	$I_{OH} = -2.6 \text{ mA}$	2.4	3.2		V	
\/ a .		V 45V	I <sub>OL</sub> = 12 mA		0.25	0.4	V	
VOL		$V_{CC} = 4.5 V$	I <sub>OL</sub> = 24 mA		0.35	0.5	V	
lozh		V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.7 V			20	μΑ	
lozL		V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 0.4 V			-20	μΑ	
II		V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 7 V			0.1	mA	
lіН		V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20	μΑ	
Ι <sub>Ι</sub> L		V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 0.4 V			-0.1	mA	
lo <sup>‡</sup>		V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-30		-112	mA	
			Outputs high		19	30		
	SN74ALS841	V <sub>CC</sub> = 5.5 V	Outputs low		38	62		
			Outputs disabled		23	40	1 .	
ICC			Outputs high		20	35	mA	
	SN74ALS842	$V_{CC} = 5.5 V$	Outputs low		48	74		
			Outputs disabled		27	44		

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



<sup>&</sup>lt;sup>‡</sup> The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I<sub>OS</sub>.

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#### switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5$ $C_L = 50$ pF R1 = 500 $\Omega$ R2 = 500 $\Omega$ T <sub>A</sub> = MIN to SN74A	UNIT		
			MIN	MAX	]	
<sup>t</sup> PLH	D	•	2	13	ns	
<sup>t</sup> PHL	U	Q	2	13	115	
<sup>t</sup> PLH	LE		7	21	ns	
<sup>t</sup> PHL	LE	Q	8	26	115	
<sup>t</sup> PZH	<del></del>	•	2	12		
tPZL	ŌĒ	Q	2	12	ns	
t <sub>PHZ</sub>	ŌĒ	Q	2	10		
<sup>t</sup> PLZ	) DE	y	2	12	ns	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

#### switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5^{\circ}$ $C_{L} = 50 \text{ pF}$ $R1 = 500 \Omega$ $R2 = 500 \Omega$ $T_{A} = \text{MIN to}$ $SN74A$ $MIN$	UNIT	
tPLH	_		4	<b>MAX</b> 18	
tPHL	D	Q	3	13	ns
t <sub>PLH</sub>	15		8	27	
t <sub>PHL</sub>	LE	Q	6	20	ns
<sup>t</sup> PZH	<del></del>		2	12	ns
t <sub>PZL</sub>	ŌĒ	Q	2	12	] 115
<sup>†</sup> PHZ	ŌĒ	Q	1	10	ns
t <sub>PLZ</sub>	)E	g L	2	12	1115

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V <sub>CC</sub>	7 V
Input voltage, V <sub>I</sub>	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T <sub>A</sub> : SN74AS841A	0°C to 70°C
Storage temperature range	-65°C to 150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



## SN74ALS841, SN74AS841A, SN74ALS842 10-BIT BUS-INTERFACE D-TYPE LATCHES WITH 3-STATE OUTPUTS

SDAS059C - DECEMBER 1983 - REVISED JANUARY 1995

## recommended operating conditions

		SN	SN74AS841A		
		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
V <sub>IL</sub>	Low-level input voltage			0.8	V
loH	High-level output current			-24	mA
loL	Low-level output current			48	mA
t <sub>W</sub>	Pulse duration, LE high	4			ns
t <sub>su</sub>	Setup time, data before LE↓	2.5			ns
t <sub>h</sub>	Hold time, data after LE $\downarrow$	2.5			ns
TA	Operating free-air temperature	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDI	SN	SN74AS841A			
PARAMETER	TEST CONDI	MIN	TYP†	MAX	UNIT	
V <sub>IK</sub>	$V_{CC} = 4.5 V,$	$I_{I} = -18 \text{ mA}$			-1.2	V
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V <sub>CC</sub> -2	2		
VOH	V <sub>CC</sub> = 4.5 V	$I_{OH} = -15 \text{ mA}$	2.4	3.2		V
	VCC = 4.5 V	$I_{OH} = -24 \text{ mA}$	2			
V <sub>OL</sub>	$V_{CC} = 4.5 V,$	$I_{OL} = 48 \text{ mA}$		0.35	0.5	V
lоzн	$V_{CC} = 5.5 V,$	V <sub>O</sub> = 2.7 V			50	μΑ
lozL	$V_{CC} = 5.5 V,$	V <sub>O</sub> = 0.4 V			-50	μΑ
ΙĮ	$V_{CC} = 5.5 V,$	V <sub>I</sub> = 7 V			0.1	mA
liн	$V_{CC} = 5.5 V,$	V <sub>I</sub> = 2.7 V			20	μΑ
Ι <sub>Ι</sub> L	$V_{CC} = 5.5 V,$	V <sub>I</sub> = 0.4 V			-0.5	mA
1 <sub>0</sub> ‡	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.25 V	-30		-112	mA
		Outputs high		36	60	
Icc	V <sub>CC</sub> = 5.5 V	Outputs low		58	94	mA
		Outputs disabled		56	93	

<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



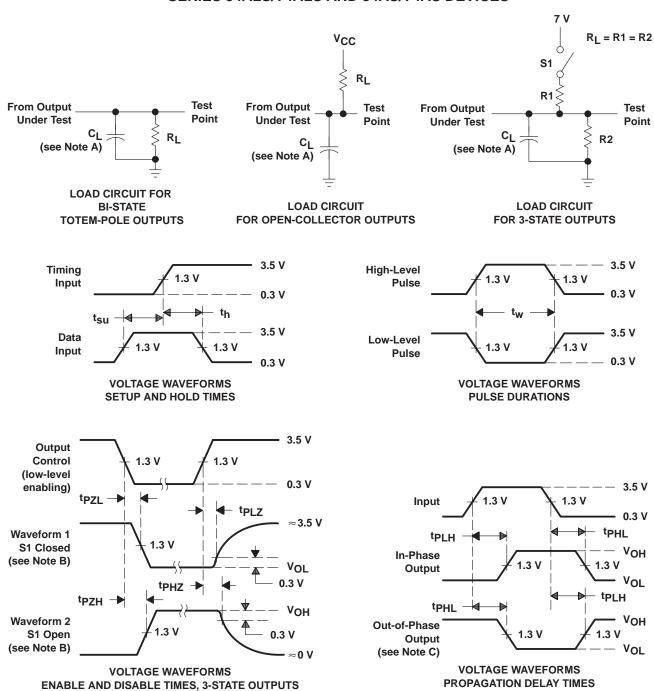
<sup>&</sup>lt;sup>‡</sup> The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, los.

## switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5$ $C_L = 50 \text{ pF}$ $R1 = 500 \Omega$ $R2 = 500 \Omega$ $T_A = \text{MIN to}$ $SN74A$	UNIT	
			MIN	MAX	1 1
t <sub>PLH</sub>	D	•	1	6.5	ns
<sup>t</sup> PHL	ט	Q	1	10.5	115
<sup>t</sup> PLH	LE		2	12	ns
<sup>t</sup> PHL	LE	Q	2	12	115
<sup>t</sup> PZH	<del></del>	•	2	14	
tPZL	ŌĒ	Q	2	16	ns
t <sub>PHZ</sub>	ŌĒ	Q	1	8	
<sup>t</sup> PLZ	) DE	g .	1	8	ns

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

#### PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- All input pulses have the following characteristics: PRR  $\leq$  1 MHz,  $t_{\Gamma} = t_{f} = 2$  ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms







11-Apr-2013

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing		Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
	(1)		Drawing		Qty	(2)		(3)		(4)	
SN74ALS841DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS841	Samples
SN74ALS841DWE4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS841	Samples
SN74ALS841DWG4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS841	Samples
SN74ALS841NT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS841NT	Samples
SN74ALS841NTE4	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS841NT	Samples
SN74ALS842DW	OBSOLETE	SOIC	DW	24		TBD	Call TI	Call TI	0 to 70		
SN74ALS842NT	OBSOLETE	PDIP	NT	24		TBD	Call TI	Call TI	0 to 70		
SN74AS841ADW	OBSOLETE	SOIC	DW	24		TBD	Call TI	Call TI	0 to 70		
SN74AS841ADWR	OBSOLETE	SOIC	DW	24		TBD	Call TI	Call TI	0 to 70		
SN74AS841ANT	OBSOLETE	PDIP	NT	24		TBD	Call TI	Call TI	0 to 70	·	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



## PACKAGE OPTION ADDENDUM

11-Apr-2013

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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# NT (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

B. This drawing is subject to change without notice.

The 28 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G24)

## PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AD.



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